

Material - Resin	High Temperature Thermoplastic
Net Weight	0.480/g
Number of Rows	1
Orientation	Vertical
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Packaging Type	Bag
Pitch - Mating Interface	1.27mm
Pitch - Termination Interface	1.27mm
Plating min - Mating	4.064µm
Plating min - Termination	4.064µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	No
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-40° to +105°C
Termination Interface: Style	Through Hole

Electrical

Current - Maximum per Contact	1.2A
Voltage - Maximum	250V

Solder Process Data

Lead-free Process Capability	WAVE
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Material Info**Reference - Drawing Numbers**

Packaging Specification	PK-90325-002-001
Product Specification	PS-99020-0011-001
Sales Drawing	SDA-90779

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